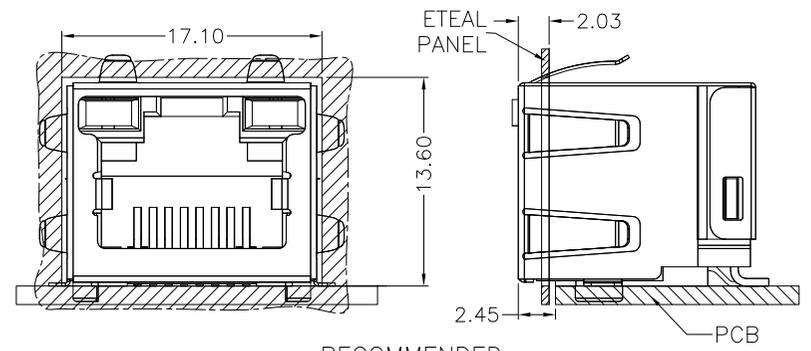
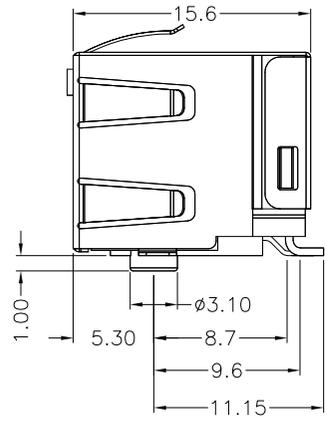
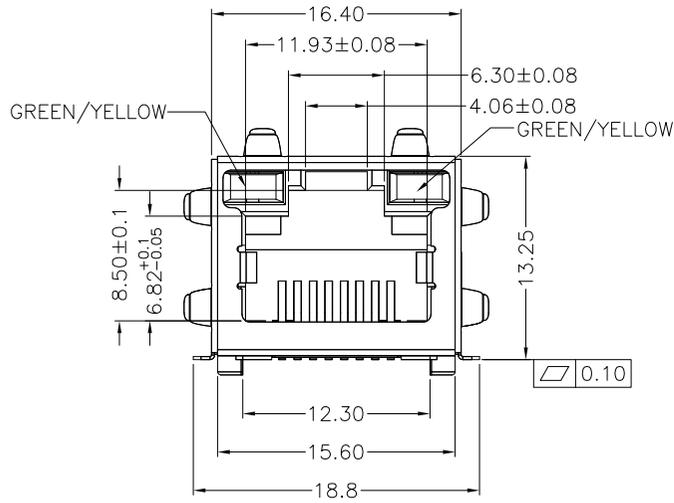


GP Component

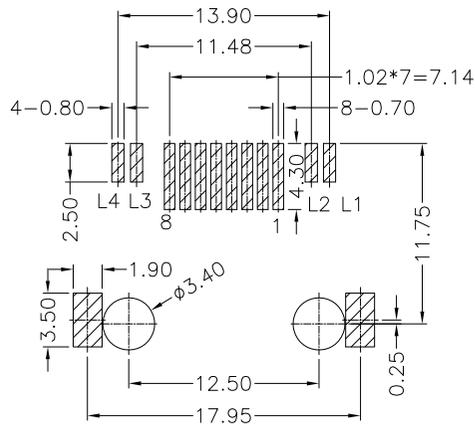
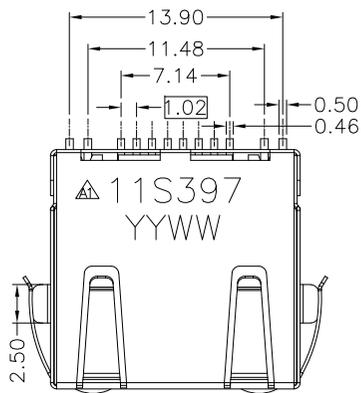
REV.	ECN NO.	LOCATIONS	DESCRIPTION	DATE	DESIGN
A0			Initial	2015/09/07	Phebe Su
A1			Add Part Number	2020/11/30	Hanson



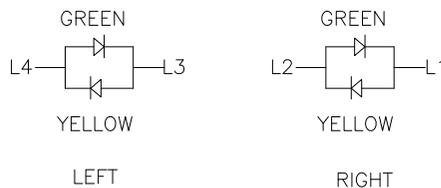
RECOMMENDED
PANEL CUTOUT DIMENSION

NOTES:

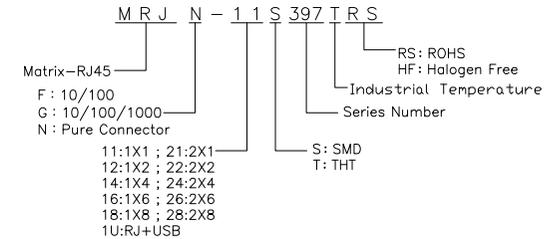
- MATERIALS:**
HOUSING: HIGH TEMP. THERMOPLASTIC, LCP, UL 94V-0, BLACK.
CONTACTS: T=0.30 mm PHOSPHOR BRONZE, 50u" NICKEL UNDERPLATE ON ALL AREA, 100u" MATTE TIN ON SOLDER TAIL, 6u" GOLD ON CONTACT AREA.
SHELL: BRASS, T=0.20mm
- OPERATING TEMPERATURE:** -40°C ~ +85°C
- LED SPEC:**
FORWARD VOLTAGE: 1.8~2.4V
REVERSE CURRENT: 5uA MAX
PEAK WAVE LENGTH
GREEN: 565~575nm
YELLOW: 585~590nm
- JACK CAVITY CONFORMS TO FCC RULES AND REGULATIONS PART 68, SUBPART F**



RECOMMENDED PCB LAYOUT (COMPONENT SIDE)
TOLERANCE ±0.05



ORDER INFORMATION :



Matrix Electronics Co., Ltd

TOLERANCE: X.X ±0.38 X.XX ±0.25 X.XXX ±0.13 ANGLE: ±3°	DESIGN BY : Hanson Huang	DATE : 2020/11/30	PART NAME: RJ45 1X1 PCB JACK WITH LED SMT TYPE	
	CHECKED BY: Vicky Hsieh	DATE : 2020/11/30	PART NO.	MRJN-11S397TRS
UNIT: mm [inch]	APPROVED BY1: Richard Hsieh	DATE : 2020/11/30	MOLD NO.	NA
SCALE: 1:1 SIZE: A4	APPROVED BY2: Richard Hsieh	DATE : 2020/11/30	DRAW NO.	
			SHEET NO.	1 OF 1